



As a below named inventor, I hereby declare hat:

My residence, post office address and citizenship are as stated below next to my name;

names are	listed below)	of the subject		aimed and f	or which a pa	itent is sou		ention entitled
	cation of which		ached hereto X		n Apri. 5	1 18,	2001	as United States Application
	nended on							(if applicable).
	nereby state th y any amendn			and the con	ntents of the	above-ider	ntified specifica	tion, including the claims, as
Ia	cknowledge th	e duty to dis	sclose information w	hich is mat	erial to patent	ability as o	defined in 37 C	FR §1.56.
inventor's d	certificate, or w and have al	§ 365(a) of a so identified	any PCT internation	al application	on which desi for patent or	gnates at le	east one country	n application(s) for patent or y other than the United States, PCT international application
<u>Country</u>			tion No.		led (Day/Mo.			(Yes/No) Priority Claimed
JAPAN JAPAN			-119025 -119028		April April			Yes Yes
belief are b made are p	elieved to be t unishable by fi	rue; and fur ne or impris	ments made herein therein therein that these states	of my own nents were der Section	knowledge ar made with the 1001 of Title	re true and e knowledg 18 of the	that all statem	ents made on information and alse statements and the like so ode and that such willful false
Full Name	of Sole or Fir	st Inventor_	K	EIJI	SATO	٠		
Inventor's	signature		2	ein >	Sato			_
Date	may ?	23, 20	001	Citize	n/Subject of _		Japan	
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	of Second Join		if any			<del>- "</del> , , , ,		
Date				Citize	n/Subject of			
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